

# GSMBSS84

## 50V P-Channel Enhancement Mode MOSFET

### Product Description

GSMBSS84, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

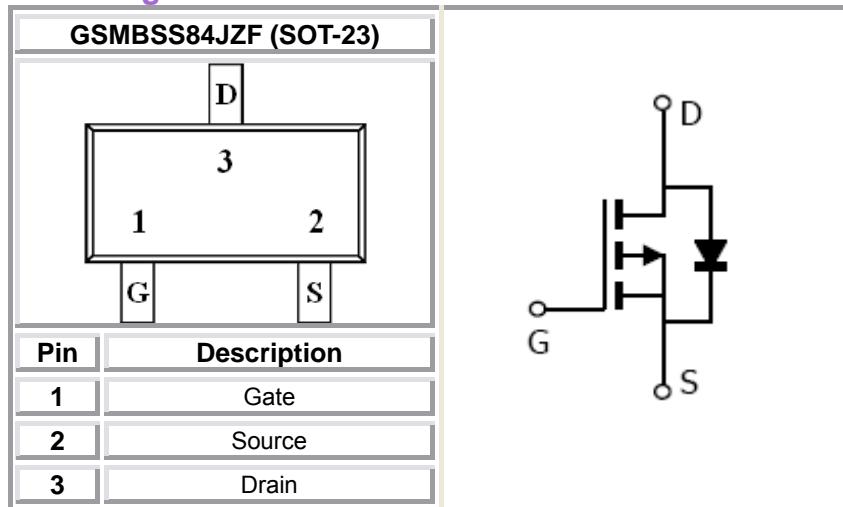
### Features

- -50V/-0.1A, $R_{DS(ON)}=10\Omega @ V_{GS}=-5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23 package design

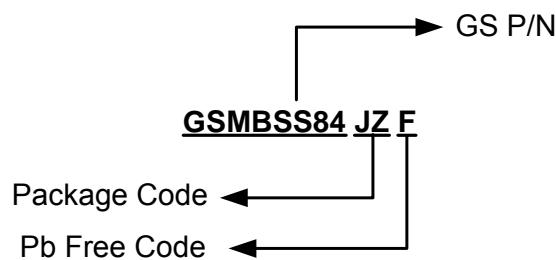
### Applications

- DC to DC Converter
- Cellular & PCMCIA Card
- Cordless Telephone
- Power Management in Portable and Battery etc.

### Packages & Pin Assignments

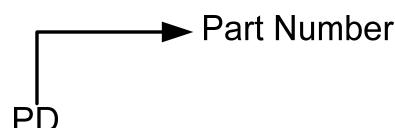


## Ordering Information



Part Number	Package	Quantity
GSMBSS84JZF	SOT-23	3000 PCS

## Marking Information



## Absolute Maximum Ratings

(T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Typical	Unit
V <sub>DSS</sub>	Drain-Source Voltage	-50	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Continuous Drain Current(T <sub>A</sub> =25°C)	-130	mA
I <sub>DM</sub>	Pulsed Drain Current (tp≤10us)	-520	mA
I <sub>S</sub>	Continuous Current	-0.13	A
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> =25°C)	225	mW
T <sub>J</sub>	Operating Junction Temperature	-55 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
R <sub>θJA</sub>	Maximax Junction to Ambient	556	°C/W

Note 1: Pulse Test: PW≤300us, Duty Cycle≤2%.

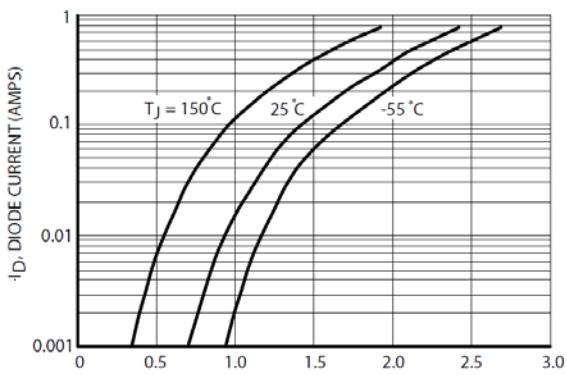
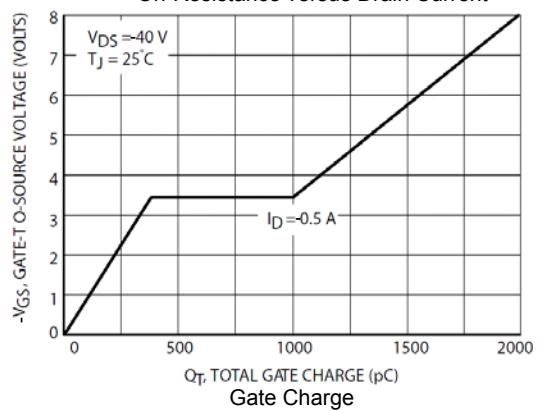
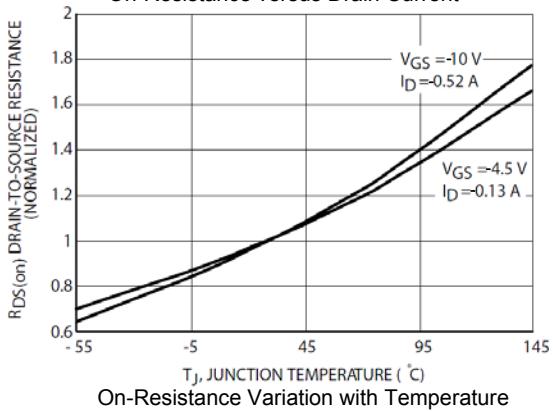
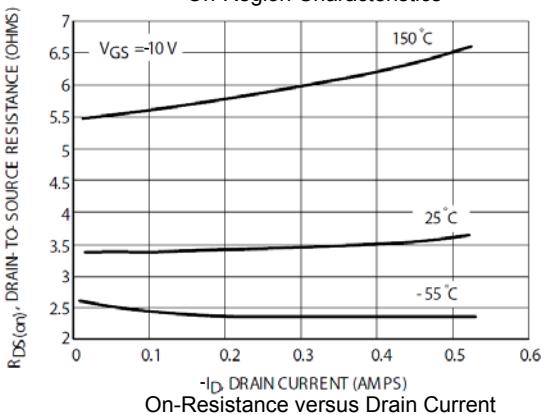
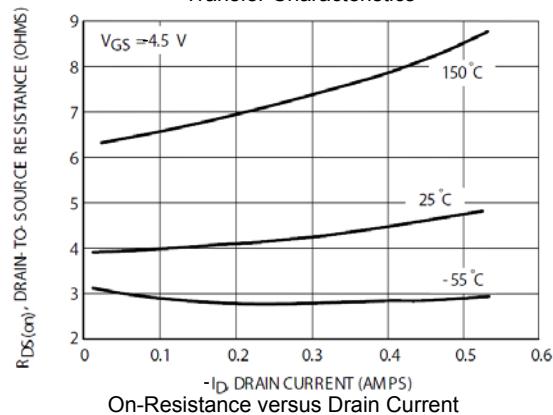
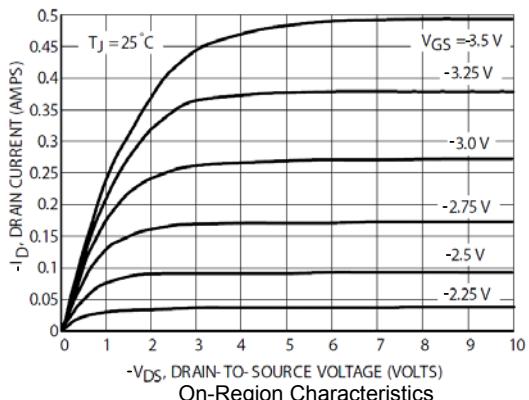
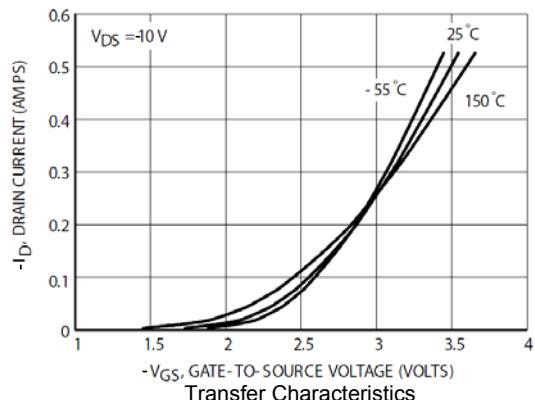
2: Switching Time is Essentially Independent of Operating Temperature.

## Electrical Characteristics

( $T_A=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-50			V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-1.0\text{mA}$	-0.8		-2.0	
$I_{GSS}$	Gate-Source Leakage Current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 60$	$\mu\text{A}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -25\text{V}, V_{GS}=0\text{V}$			-0.1	$\mu\text{A}$
		$V_{DS} = -50\text{V}, V_{GS}=0\text{V}$			-15	
$R_{DS(\text{on})}$	Drain-Source On-Resistance	$V_{GS}=-5\text{V}, I_D=-100\text{mA}$		5.0	10	$\Omega$
$g_{fs}$	Forward Transconductance	$V_{DS}=-25\text{V}, I_D=-100\text{mA}, f=1.0\text{KHz}$	50			$\text{mS}$
$V_{SD}$	Forward Voltage				-2.5	V
<b>Dynamic</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=-5\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$		30		$\text{pF}$
$C_{oss}$	Output Capacitance			10		
$C_{rss}$	Reverse Transfer Capacitance			5.0		
$Q_G$	Gate Charge			6		$\text{nC}$
$t_{d(on)}$	Turn-On Time	$V_{DD}=-15\text{V}, R_L=50\Omega, I_D=-2.5\text{A}$		25		$\text{ns}$
$t_r$				1.0		
$t_{d(off)}$	Turn-Off Time			16		
$t_f$				8.0		

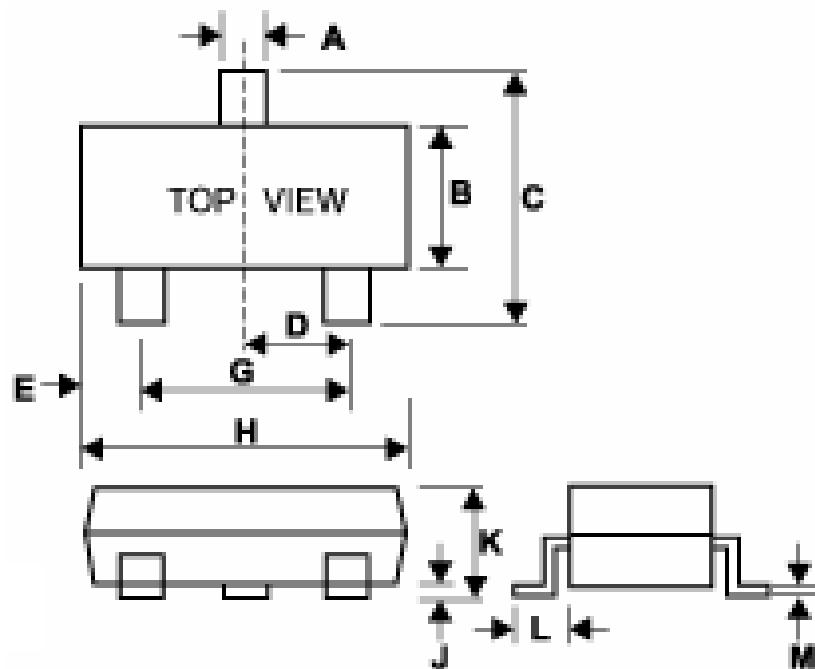
## Typical Performance Characteristics



Body Diode Forward Voltage

## Package Dimension

### SOT-23



### Dimensions

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.35	0.51	0.013	0.020
B	1.19	1.80	0.046	0.070
C	2.10	3.00	0.082	0.118
D	0.85	1.05	0.033	0.041
E	0.46	1.00	0.018	0.039
G	1.70	2.10	0.066	0.082
H	2.70	3.10	0.106	0.122
J	0.01	0.13	0.0003	0.005
K	0.89	1.60	0.035	0.062
L	0.30	0.61	0.011	0.024
M	0.076	0.25	0.002	0.009

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